

# CERTIFICATE OF COMPLIANCE

**Certificate Number** 20141125-E232195  
**Report Reference** E232195-20061020  
**Issue Date** 2014-NOVEMBER-25

**Issued to:** TEXAS INSTRUMENTS INC  
2900 SEMICONDUCTOR DR  
PO BOX 58090  
SANTA CLARA CA 95052-8090

**This is to certify that  
representative samples of**

COMPONENT - TEMPERATURE-INDICATING AND -  
REGULATING EQUIPMENT

USR Component – Temperature Sensing Integrated Circuit  
Device, Models LM94021 and LM94022, may be followed  
by Q, followed by BI, followed by MG, may be followed by  
X, may be followed by alphanumeric characters

Have been investigated by UL in accordance with the  
Standard(s) indicated on this Certificate.

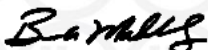
**Standard(s) for Safety:** Standard for Temperature-Indicating And –Regulating  
Equipment, UL 873

**Additional Information:** See the UL Online Certifications Directory at  
[www.ul.com/database](http://www.ul.com/database) for additional information

Only those products bearing the UL Certification Mark should be considered as being covered by UL's  
Certification and Follow-Up Service.

Recognized components are incomplete in certain constructional features or restricted in performance  
capabilities and are intended for use as components of complete equipment submitted for investigation rather  
than for direct separate installation in the field. The final acceptance of the component is dependent upon its  
installation and use in complete equipment submitted to UL LLC.

Look for the UL Certification Mark on the product.



Bruce Mahrenholz, Assistant Chief Engineer, Global Inspection and Field Services

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